



SPECIFICATION FOR APPROVAL

CUSTOMER	
NOMINAL FREQUENCY	32.768 KHz
PRODUCT TYPE	TYPE G9 SMD CRYSTAL
SPEC. NO. (P/N)	G93270003
CUSTOMER P/N	
ISSUE DATE	Jan.28,2019
VERSION	C

APPROVED	PREPARED	QA
Brenda	Clane	Don't Land

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*RoHS Compliant

*HF-Halogen Free

*REACH Compliant

E0-R-4-014 Rev. F

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VERSION HISTORY

Version No.	Version Date	Description	Notes
А	Sep.12,2012	Initial Release	
В	Apr.1,2014	Revised to RoHS Compliant	
С	Jan.28,2019	Updated logo	

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ELECTRICAL SPECIFICATIONS

SRe Part Number: G93270003

Parameters	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	32.768	KHz	
Frequency Tolerance	FT	± 10	ppm	at 25°C ± 5°C
Load Capacitance	CL	12.5	pF	Тур.
Drive Level	DL	0.1 / 0.5	μW	Typ. / Max.
Equivalent Series Resistance	ESR	90	ΚΩ	Max.
Temperature Coefficient	K	-0.03	ppm/°C ²	Тур.
Operating Temperature Range	TR	-40 to +85	°C	
Shunt Capacitance	C0	7	pF	Max.
Storage Temperature Range		-55 to +85	°C	
Aging		± 3	ppm	Max 1st year
Insulation Resistance	_	500	ΜΩ	Min.

Reliability (Mechanical and environmental performances)

No.	Test Items	Conditions	Requirements
1	Bending test	Apply pressure in the direction of the arrow at a rate of about 0.5mm/s until bent width reaches 5mm, and hold for 30 seconds.	Without mechanical damage such as breaks and satisfy sealing specification. Frequency change: Within ±5ppm
2	Shear test	A static load of 20N(2.04kgf) using a R0.5 scratch tool, shall be applied on the core of the component and in the direction of the arrow and held for 5 seconds.	Equivalent series resistance(E.S.R) change: Within 5kΩ
3	Core body strength	A static load of 10N(1.02kgf) using a R0.5 pressure rod shall be applied to the center in the direction of the arrow and held for 10 seconds.	
4	Vibration	Endurance conditioning by a frequency sweep shall be made. The entire frequency range, from 10Hz to 55Hz and return to 10Hz, shall be transversed in 1 minute. Amplitude (total excursion): 1.5mm, This motion shall be applied for a period of 2 hours in each of 3 mutually perpendicular axes (a total of 6 hours). For other procedures, refer to JIS C 60068-2-6.	
5	Shock	Peak acceleration: 9810m/s2, Duration of the pulse: 1ms, Three successive shock shall be applied 3 times perpendicular axes. For other procedures, refer to JIS C 60068-2-27.	

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6	Cold	Quartz crystal units shall be st atmosphere for 1000 hours. O to JIS C 60068-2-1.		Frequency change: Within ±5ppm Equivalent series resistance(E.S.R) change: Within 5kΩ
7	Dry heat	Quartz crystal units shall be st atmosphere for 100 hours. Oth JIS C 60068-2-2.		After conditioning, quartz crystal units shall be subjected to standard atmospheric conditions for 1 hour, and measured.
8	Damp heat	Quartz crystal units shall be st atmosphere with 90 to 95% re hours. Other procedures confo		
9	Change of temperature	Quartz crystal units shall be so cycles of temperature change procedures conform to JIS C (shown below. Other	
		Temperature 1 -40±3°C 2 Normal temperature 3 100±2°C 4 Normal temperature	30min.	
10	Sealing	Both the test methods specific Quartz crystal units shall be so temperature hot water for 5 mi Quartz crystal units shall be te spectrometric leakage detectorate of helium gas.	paked in 90°C or higher inutes.	Without repetitive leaking bubbles from quartz crystal units. 1×10-9 Pa·m3/s or less
11	Aging	Quartz crystal units shall be st atmosphere for 720±12 hours.		 Frequency change: Within ±5ppm Equivalent series resistance(E.S.R) change: Within 5kΩ After conditioning, quartz crystal units shall be subjected to standard atmospheric conditions for 1 hour, and measured.
12	Solder-ability	Terminals coated with flux sha solder bath for 3.5±0.5 second		Minimum 95% of immersed terminal shall be covered with new uniform solder.
		Items	Conditions	
			n-3.0Ag-0.5Cu	
		2 Flux m	oproximately 25wt% ethanol(JIS K 8891) olution of resin(JIS K 902).	
		3 Solder temperature 25	55±5°C	



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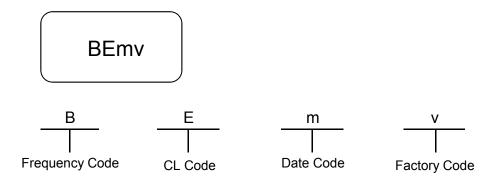
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13	Resistance to	Reflow soldering method
	soldering heat	'
	3	Temperature profile
		Soldering 220 - 60±10s Slow cooling(Stored at room temperature)
		€ 90±10s Within 5s
		Peak temperature: $260\pm5^{\circ}$ C for within 5seconds. Soldering temperature: 220° C or higher for 60 ± 10 seconds. • Frequency change: Within ±5 ppm • Equivalent series resistance (E.S.R) change: Within $10k\Omega$
		Pre-heating temperature: 160±10°C for 90±10 seconds. Quartz crystal units which is put on PCB shall be through reflow soldering furnace twice with the condition • After conditioning, quartz crystal units shall be subjected to standard atmospheric conditions for 1 hour, and measured.
		shown above. • Without distinct deformation in appearance.
		Soldering iron method • Frequency change: Within ±5ppm
		Terminals shall be applied 400±10 $^{\circ}$ C soldering iron heat for 3.5±0.5 seconds twice. • Equivalent series resistance(E.S.R) change: Within 5k Ω
		After conditioning, quartz crystal units shall be subjected to standard atmospheric conditions for 1 hour, and measured.
		Without distinct deformation in appearance.
14	Solubility to resistance	 Soak cleaning Quartz crystal units shall be soaked in isopropyl alcohol at normal temperature for 90 seconds. Without mechanical damage such as breaks and satisfy sealing specification. Frequency change: Within ±5ppm Equivalent series resistance(E.S.R) change: Within 5kΩ
		 Without distinct deformation in appearance. Marking shall be legible.

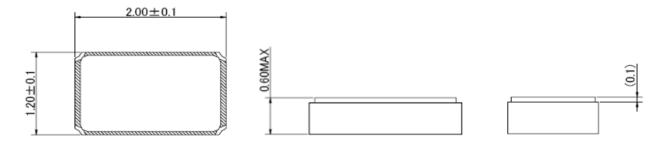
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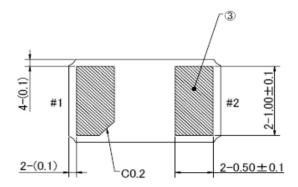
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Marking

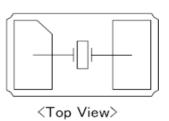


Dimensions (Units: mm)

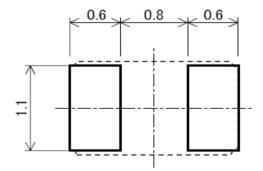




Internal connection



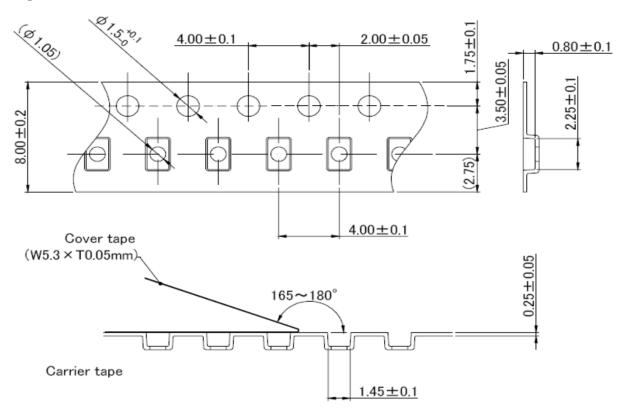
Land dimensions(unit: mm)



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TAPING



REEL

